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Application Number 09/827,421

Filing Date 04/06/2001

First Named Inventor Tree

Group Art Unit 2681

Examiner Name

Attorney Docket Number Sony-03300

Total Number of Pages in This Submission

8

## ENCLOSURES (check all that apply)

☐ Fee Transmittal Form☐ Fee Attached☐ Amendment / Response☐ After Final☐ Affidavits/declaration(s)☒ Revocation of Power of Attorney☒ Power of Attorney with Change of Correspondence Address☒ Statement Under 37 CFR 3.73(b) for Sony Electronics☒ Statement Under 37 CFR 3.73(b) for Sony Corporation☐ Copy of the Assignment☐ Response to Missing Parts under 37 CFR 1.52 or 1.53☒ Postcard☒ Authorization from Mr. Leshner☒ Limited Authorization from Mr. Leshner☒ Authorization from Mr. Fujii☐☐☐ Terminal Disclaimer☐ Small Entity Statement☐ Request of Refund

Remarks

The Commissioner is hereby authorized to charge any additional fees associated with this communication or credit overpayment to Deposit Account No: 50-1963. A duplicate copy of this authorization is enclosed.

☐ After Allowance Communication to Group☐ Appeal Communication to Board of Appeals and Interferences☐ Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)☐ Proprietary Information☐ Executed Declaration☐ Additional Enclosure(s) (please identify below):

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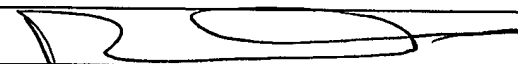
Technology Center 2600

## SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

Firm or Individual name

Richard H. Butt

Signature



Date

9/30/2002

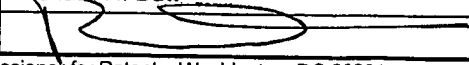
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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on this date:

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SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.